# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

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Micro Commercial Components 20736 Marilla Street Chatsworth CA 91311 Phone: (818) 701-4933 Fax: (818) 701-4939

## SI3139KE

### **Features**

- Lead Free Product is Acquired
- Halogen free available upon request by adding suffix "-HF"
- Epoxy meets UL 94 V-0 flammability rating
- Moisture Sensitivity Level 1
- Operated at Low Logic Level Gate Drive
- P-Channel Switch with Low R<sub>DS</sub>(on)
- Surface Mount Package
- Marking : 39K

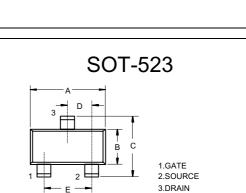
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#### Absolute maximum ratings @ 25 °C

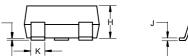
Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source Voltage	-20	V
V <sub>GS</sub>	Gate-source Voltage	±12	V
ID	Continuous Drain Current	-0.66	А
I <sub>DM</sub>	Pulsed Drain Current	-1.2	А
PD	Total Power Dissipation	150	mW
ТJ	Operating Junction Temperature	-55 to +150	°C
T <sub>STG</sub>	Storage Temperature -55 to +		°C
ΤL	Lead Temperature for Soldering Purposes 260		°C
RthJA	Thermal Resistance fromJunction to Ambient 833 °C/W		°C/W

### Electrical Characteristics @ 25°C Unless Otherwise Specified

Symbol	Parameter			Тур	Max	Units
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage (V <sub>GS</sub> =0Vdc, I <sub>D</sub> =-250µAdc)					Vdc
$V_{\text{GS(th)}}$	Gate-Threshold Voltage (V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uAdc)		-0.35		-1.1	Vdc
I <sub>GSS</sub>	Gate-body Leakage (V <sub>DS</sub> =0Vdc, V <sub>GS</sub> =	=±10Vdc)			±20	uA
I <sub>DSS</sub>	Zero Gate Voltage Drain Current (V <sub>DS</sub> =-20Vdc, V <sub>GS</sub> =0Vdc)				-1	uAdc
$V_{\text{SD}}$	Diode Forward Voltage (I <sub>s</sub> =-0.5A,V <sub>Gs</sub> =0V				-1.2	Vdc
r <sub>DS(on)</sub>	Drain-Source On-Resistance (V <sub>GS</sub> =-4.5Vdc, I <sub>D</sub> =-1Adc) (V <sub>GS</sub> =-2.5Vdc, I <sub>D</sub> =-0.80Adc) (V <sub>GS</sub> =-1.8Vdc, I <sub>D</sub> =0.5Adc)		 	  0.95	0.52 0.70 	Ω
<b>g</b> fs	Forward transconductance (V <sub>DS</sub> =-10Vdc, I <sub>D</sub> =0.54Adc)			1.2		S
Ciss	Input Capacitance	V <sub>DS</sub> =-16Vdc.		113	170	
Coss	Output Capacitance	$V_{\rm DS}$ =-16VdC, V <sub>GS</sub> =0VdC		15	25	pF
C <sub>rSS</sub>	Reverse Transfer capacitance	f=1MHz		9	15	P .
t <sub>d(on)</sub>	Turn-on Time	Vgs=-4.5V,Vds=-10V,		9.0		
$t_{d(off)}$	Turn-off Time	I <sub>D</sub> =-200mA		32.7		ns
tr	Rise Time	$R_{GEN}$ =10 $\Omega$		5.8		
t <sub>f</sub>	Fall Time			20.3		



**P-Channel MOSFET** 



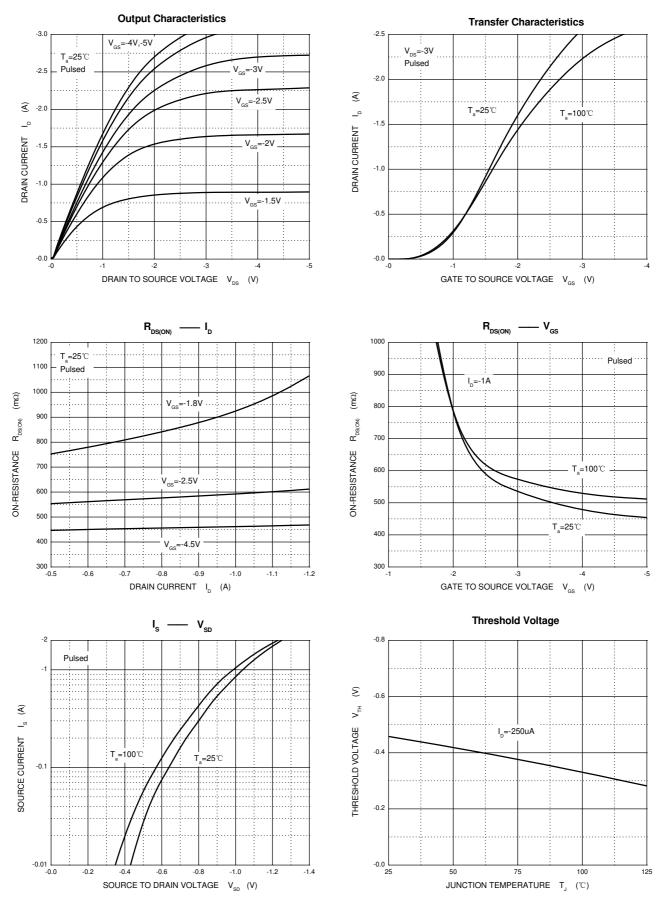


DIMENSIONS					
	INCHES		ММ		
DIM	MIN	MAX	MIN	MAX	NOTE
Α	.059	.067	1.50	1.70	
В	.030	.033	0.75	0.85	
С	.057	.069	1.45	1.75	
D	.020 No	ominal	0.50Nom	inal	
E	.035	.043	0.90	1.10	
G	.000	.004	.000	.100	
Н	.028	.031	.70	0.80	
J	.004	.008	.100	.200	
ĸ	010	014	25	35	

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### **Typical Characteristics**



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### Ordering Information :

Device	Packing
Part Number-TP	Tape&Reel: 3Kpcs/Reel

Note : Adding "-HF" suffix for halogen free, eg. Part Number-TP-HF

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